

2SD2528

Silicon NPN epitaxial planar type

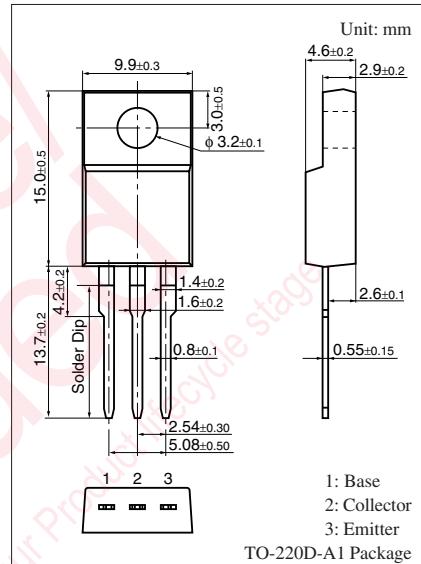
For power amplification and high-current amplification

■ Features

- High forward current transfer ratio h_{FE}
- Satisfactory linearity of forward current transfer ratio h_{FE}
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	80	V
Collector-emitter voltage (Base open)	V_{CEO}	60	V
Emitter-base voltage (Collector open)	V_{EBO}	6	V
Collector current	I_C	5	A
Peak collector current	I_{CP}	10	A
Base current	I_B	1	A
Collector power dissipation	P_C	40	W
Junction temperature	T_j	2.0	
		150	°C
Storage temperature	T_{stg}	-55 to +150	°C



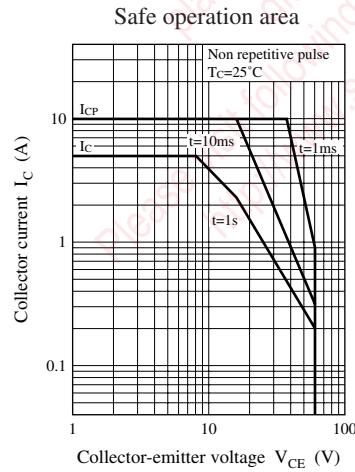
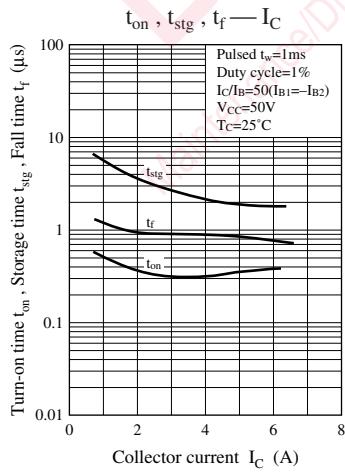
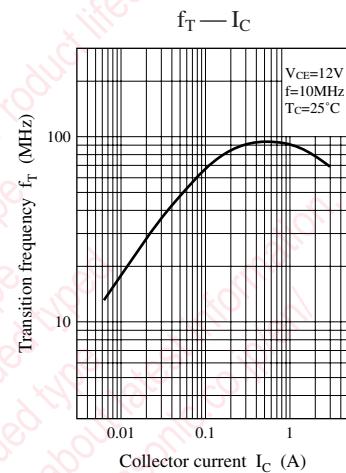
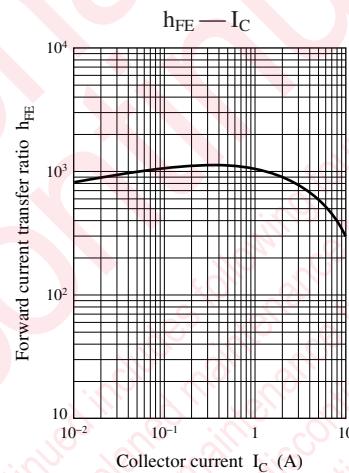
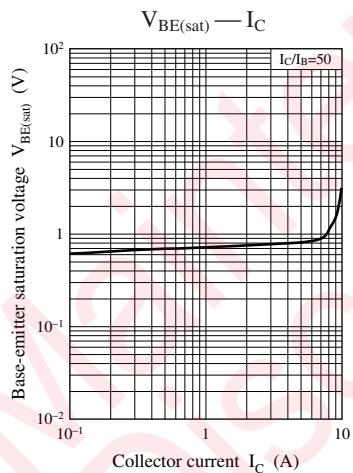
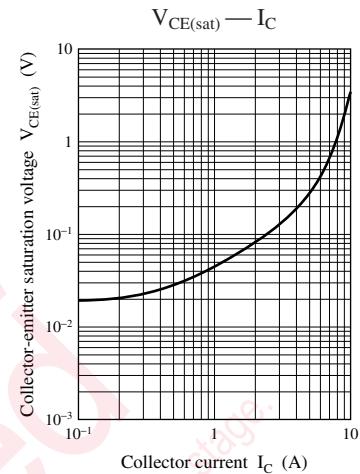
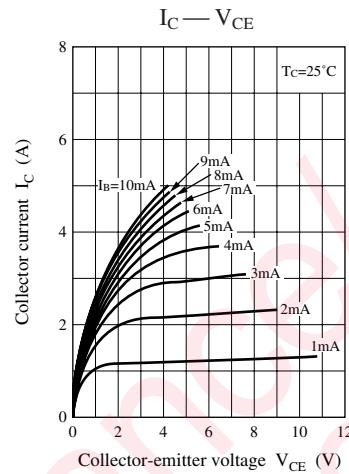
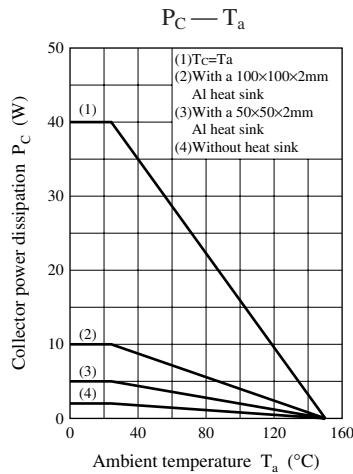
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = 25 \text{ mA}, I_B = 0$	60			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 80 \text{ V}, I_E = 0$			100	μA
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 6 \text{ V}, I_C = 0$			100	μA
Forward current transfer ratio	h_{FE}^*	$V_{CE} = 4 \text{ V}, I_C = 1 \text{ A}$	500		2000	—
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$I_C = 4 \text{ A}, I_B = 0.1 \text{ A}$			0.3	V
Transition frequency	f_T	$V_{CE} = 12 \text{ V}, I_C = 0.4 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	t_{on}	$I_C = 4 \text{ A}, I_{B1} = 0.08 \text{ A}, I_{B2} = -0.08 \text{ A}$		0.4		μs
Storage time	t_{stg}	$V_{CC} = 50 \text{ V}$		2.0		μs
Fall time	t_f			0.6		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	Q	P
h_{FE1}	500 to 1 200	800 to 2 000



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